

Product Specification

XBLW AOD403

P-Channel Enhancement Mode MOSFET

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Description

The AOD403 uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

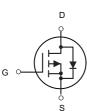
General Features

- VDS = -30V ID =-70 A
- RDS(ON) < 10mΩ @ VGS=-10V</p>

Application

- Battery protection
- Load switch
- > Uninterruptible power supply





P-Channel MOSFET

Package Marking and Ordering Information

Product Model	Package Type	Marking	Packing	Packing Qty
XBLW AOD403	TO-252-2L	AOD403	Таре	2500Pcs/Reel

Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	-30	V
VGS	Gate-Source Voltage	±20	V
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ -10V ^{1,6}	-70	А
I₀@Tc=100°C	Continuous Drain Current, V _{GS} @ -10V ^{1,6}	-50	А
Ідм	Pulsed Drain Current ²	-200	А
EAS	Single Pulse Avalanche Energy ³	80	mJ
las	Avalanche Current	-40	А
P₀@Tc=25°C	Total Power Dissipation ⁴	90	W
Тѕтс	Storage Temperature Range	-55 to 175	°C
TJ	Operating Junction Temperature Range	-55 to 175	°C
_	Thermal Resistance Junction-ambient $^{1}(t \leq 10S)$	20	°C/W
Reja	Thermal Resistance Junction-ambient ¹ (Steady State)	50	°C/W
Rejc	Thermal Resistance Junction-case ¹	1.6	°C/W



Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V
		V _{GS} =-10V , I _D =-20A		7	10	mΩ
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =-4.5V , I _D =-15A		11	18	mΩ
$V_{\text{GS(th)}}$	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-1.2		-2.5	V
		$V_{\text{DS}}\text{=-24V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$			-1	
IDSS	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , Tյ=55℃			-5	uA
lgss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.2		Ω
Qg	Total Gate Charge (-10V)			60		
Qgs	Gate-Source Charge	─V _{DS} =-15V , V _{GS} =-10V		9		nC
Qgd	Gate-Drain Charge	─ I _D =-18A		15		
Td(on)	Turn-On Delay Time			17		
Tr	Rise Time	─V _{DD} =-15V V _{GS} =-10V		40		ns
Td(off)	Turn-Off Delay Time	R _G =3.3Ω,		55		
T _f	Fall Time			13		
Ciss	Input Capacitance			3450		
Coss	Output Capacitance	─_ V _{DS} =-25V , V _{GS} =0V , f=1MHz		255		pF
Crss	Reverse Transfer Capacitance	-		140		
ls	Continuous Source Current ^{1,5}	$V_G=V_D=0V$, Force Current			-70	A
Vsd	Diode Forward Voltage ²	V _{GS} =0V , Is=-1A , Tյ=25℃			-1.2	V
trr	Reverse Recovery Time	l⊧=-20A , di/dt=100A/µs ,		22		nS
Qrr	Reverse Recovery Charge	—T」=25℃		72		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=-}50\text{V}, V_{\text{GS}}\text{=-}10\text{V}, \text{L=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=-}40\text{A}$

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation

6. The maximum current rating is package limited.



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Typical Characteristics

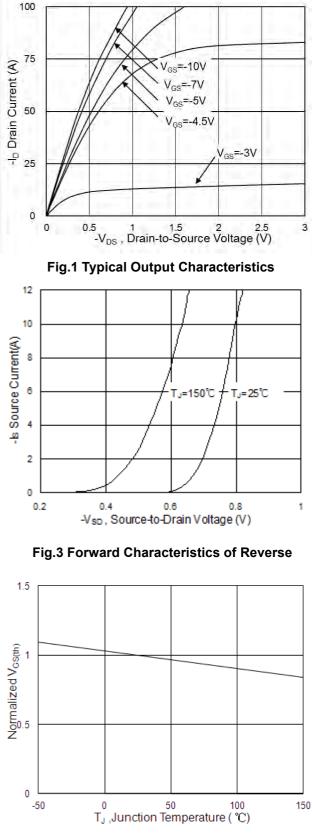


Fig.5 Normalized -V_{GS(th)} vs. T_J

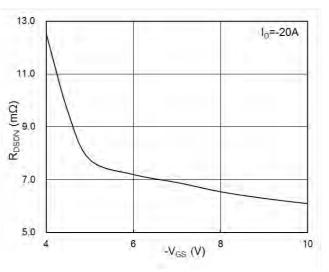


Fig.2 On-Resistance vs. Gate-Source Voltage

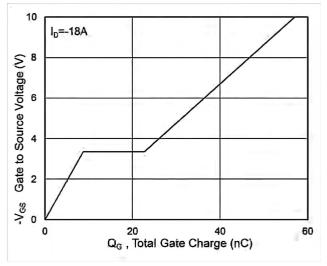


Fig.4 Gate-Charge Characteristics

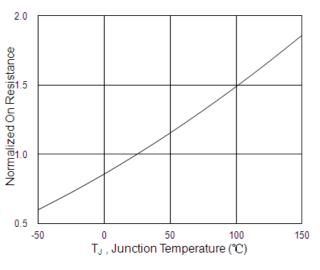


Fig.6 Normalized R_{DSON} vs. T_J



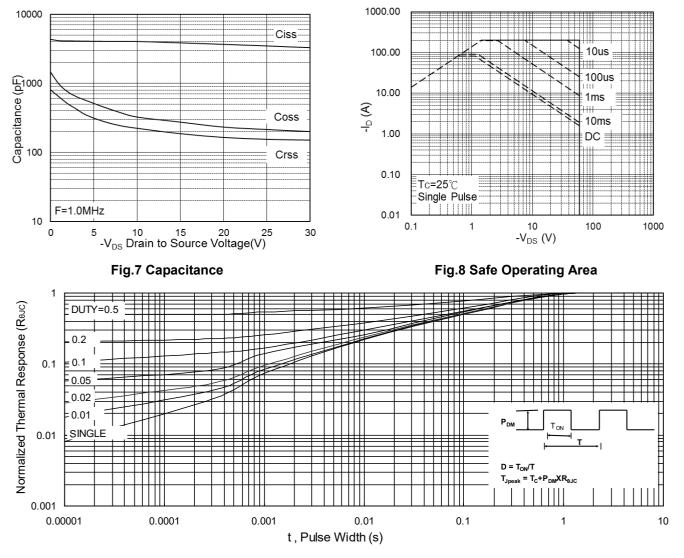


Fig.9 Normalized Maximum Transient Thermal Impedance

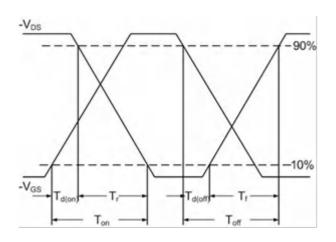
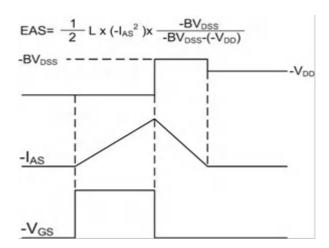
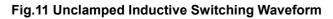


Fig.10 Switching Time Waveform

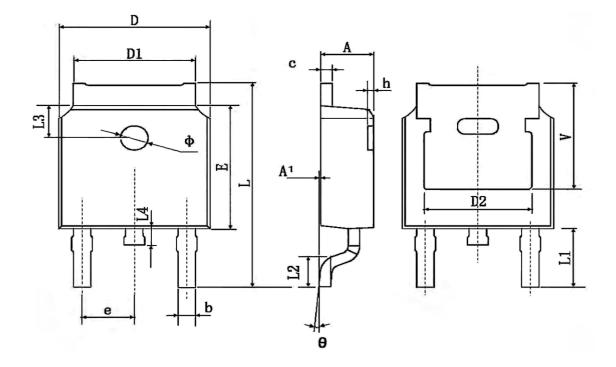






Package Information

TO252-2L



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
с	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0.	8.	0.	8.	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.211 TYP.		





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